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# FerVID family FRAM RFID LSI





## FerVID family

FUJITSU SEMICONDUCTOR LIMITED

## **Expand the Possibilities of Your RFID Tags with FRAM**

## Introducing Fujitsu Semiconductor's FRAM RFID LSI; *FerVID family*\*

FRAM ('Ferroelectric RAM') is the non-volatile memory that outperforms the conventional non-volatile memories E<sup>2</sup>PROM and Flash. Unlike E<sup>2</sup>PROM and Flash, FRAM does not require a higher internal voltage for writing operation, and this feature provides you with virtually unlimited read/write endurance, and fast writing speed. This advantage realizes large density of storage memory and stable communication distance for read and write operation. And unlike E<sup>2</sup>PROM and Flash, FRAM is resistant to sterilization by gamma-ray. Thus more and more RFID tag manufacturers around the world are selecting Fujitsu's *FerVID family* of FRAM RFID LSI as the best RFID for data carriers.



FRAM RFID Can Realize a Wider Range of RFID Applications than Ever Before Fujitsu's *FerVID family* consists of large density FRAM which are available

for HF (13.56MHz) and UHF (860MHz–960MHz) applications. The feature of large density memory is perfect for RFID use in factory automation, maintenance, asset management, and logistic tracking. And the feature of gamma-ray sterilization hardness is perfect for RFID use in the medical, pharmaceutical, biomedical, foods, and cosmetic industries. Moreover, the serial interface feature enables RFID to connect a microcontroller, and expands the possibilities of RFID into the realm of embedded applications.



FA, Maintenance

## Complete Visibility of Production and Real Time Operations

Large density memory and fast writing will improve the operational efficiency and quality of production in the factory



### Great Promise as Data Carrier Tags

\* FerVID family is a trademark of Fujitsu Semiconductor Limited





dustries, but other industries as well—a partial listing of which would include: the electricity industry, the construction industry, the infrastructure, transportation (vehicle, track, road), and rental machinery industries, and the facilities management industries (gas, water, chemicals, and oil).

## Medical / Pharmaceutical / Biomedical

## Gamma-ray Sterilization Hardness Enables Total Traceability

Due to its resistance to gamma-ray sterilization, FRAM RFID makes possible total traceability of medical instruments and packages from production to waste management.

The remarkable feature of FRAM RFID for healthcare applications is strong radiation hardness, which permits RFID to be attached to products to be sterilized by gamma-ray. Unlike conventional memory used for RFID, the data stored in FRAM survives gamma-ray sterilization. This feature is of great are continuously seeking to improve the safety and reliability of traceability

### Traceability of Products

Unlike conventional RFID tags, FRAM RFID tags can be placed on a medical or pharmaceutical product at the production stage before gamma-ray sterilization takes place from outside the package. After shipment, RFID tags can record the history of the logistic process as well. Thus, FRAM RFID enables complete visibility during all stages of the process, and thereby



#### Traceability in Hospitals



and after operations. Patient medication must be executed with flawless accuracy. These are some of the areas where FRAM RFID can help. Also, the penetration of NFC smart phones and tablet terminals into the medical scene may increase potential applications of FRAM RFID.



Identification, Optimization Medication to Patient Fluid System (connection matching)



Gamma-ray/E-Beam Sterilization Radiation to Blood Products





Traceability Logistics and Warehousing









## **Embedded** RF

## Serial Interface for Creating New Value

New applications can be created by connecting FRAM RFID to microcontrollers and sensors

The serial interface feature of RFID LSI makes it possible to add value

#### Environment Monitoring

logistic process, establishing better traceability management for quality control and product safety. For example, RFID can be



### **Operating Parameter Setting**

connected. In product distribution, for example, the parameter data for individual customers can be written in FRAM even after the product is packed, and in the same way important traceability information and keys can be added during the logistic process or after arrival at the retail site. Then when the product is used for the first time, the microcontroller can load the data stored in FRAM to activate the product, or if the data is missing, the product may not be activated. Also if FRAM is used for parameter memory, the operational condition of the microcontroller can be changed by RF.









## FerVID family for UHF Passive RFID MB97R803A/B, MB97R804A/B, MB97R7051

- ISO/IEC18000-6C, EPC C1G2 Ver.1.2.0 compliant
- Worldwide UHF frequency (860–960MHz)
- Large memory density and fast writing performance
- Stable communication distance between writing and reading (the same distance)
- Write Lock and Read Lock feature with password
- Anti-collision feature
- Serial interface for Embedded RF solutions
- (Evaluation board with FM3 family microcontroller and sensors)

	MB97R803A	MB97R803B	MB97R804A	MB97R804B	MB97R7051
Memory size	4K Bytes (32K bits) 72K Bytes			72K Bytes	
User memory size	3,424 Bytes 64K Bytes				
Operating frequency	860 — 960MHz				
Modulation	DSB-ASK, SSB-ASK, PR-ASK				
Data coding	FM0, Miller Subcarrier (M=2,4,8)				
Baudrate (Reader to RFID)	40kbps — 160kbps (0 data transmission)				
Baudrate (RFID to Reader)	40kbps — 640kbps				
Read/write sensitivity	-6 dBm				
Command (RF)	EPC C1G2 Ver.1.2.0 commands Block Permalock Read Lock (custom)				
Serial interface				_	
Serial input frequency	-		2MHz (Max)		_
Serial input voltage	- 2.3-3.6V -			-	
Command (serial)	- Read, Write		Write	-	
Data retention	10 years (+55°C)				
Read/Write endurance	10 <sup>10</sup> times				
Evaluation kit	-			Yes	-
Shipping Form	Wafer	Package TSSOP-16	Wafer	Package TSSOP-16	Wafer, Package Thin type QFN-40

## FerVID family for HF Passive RFID MB89R118C, MB89R119B, MB89R112

- ISO/IEC15693, 18000-3/Mode1 compliant
- Large memory density and fast writing performance
- Fast reading performance with custom commands
- Outstanding gamma-ray radiation hardness
- Anti-collision feature
- High-input capacitance for antenna downsizing requirements
- Serial interface for embedded RF solutions (in development)
- Ucode tag certification by Ubiquitous ID Center

	MB89R118C	MB89R119B	MB89R112		
Memory size	2K(16K bits)	256Bytes(2,048 bits)	9K Bytes(72K bits)		
User memory size	2,000Bytes	232Bytes	8192Bytes		
Block structure	8Bytes, 256Blocks	4Bytes, 64Blocks	32Bytes, 256Blocks		
Operating frequency	13.56MHz ± 7kHz				
Modulation	ASK10/100%				
Data coding	1 out of 4(1out of 256 is not supported)				
Sub-carrier	One sub-carrier (Two sub-carrier is not supported)				
Baudrate	26.48, 52.97kbps (Response to Fast command)				
Commands	ISO15693 commands, Custom commands(Fast Read/Write,EAS)	ISO15693 commands, Custom commands(Kill,Fast Read/Write,EAS)	ISO15693 commands, Custom commands (Fast Read/Write)		
Input capacitance	24pF/96pF				
Serial interface		SPI			
Data retention	10 years (+85°C)				
Read/Write endurance	10 <sup>12</sup> times				
Shipping Form	Diced Wafer (Plating bump,	Diced Wafer (Plating bump, Backwrapped up to 150um) Package QFN-24			
Fail Die detection	MAP (.xml format), Bad Mark (option)				

## RFID Development Kit for Embedded Use MB9BF506RA-EVB-RF-01

The microcontroller board, equipped with the FM3 Microcontroller MB9BF506R, and the antenna board, equipped with the MB97R804B, are joined through an SPI interface. The microcontroller board has temperature, humidity and illuminant sensors, a 3-axis accelerometer, a clock function and an LCD, which are connected to it through a I<sup>2</sup>C interface. Sensor data collected periodically can be LCD displayed, and applications which can read by a reader/writer can be run. The main frequency of the antenna board is about 920MHz. When the board is connected to a PC through a USB connector on it, microcontroller firmware can be written on the board. Demos and programs can be created and executed for evaluation. And the board can be used through an ICE interface as firmware for a microcontroller development kit.



## FerVID family Production Roadmap

